

# **RENESAS SEMICONDUCTOR RELIABILITY REPORT**

GROUP : RX72N  
DEVICE : R5F572NXXX  
APPLICATION : Consumer / Industry

Quality Assurance Div.  
Renesas Electronics Corporation

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**Table. Reliability test results (QFP)**

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 °C to 150 °C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 °C, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

\*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

**Table. Reliability test results (BGA)**

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 °C to 125 °C , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

\*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

**Table. Reliability test results (LGA)**

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 °C to 125 °C , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

\*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation ( $\lambda$ )

$$\lambda = \lambda_b \times \pi T \text{ (FIT)}$$

①Unique failure rate ( $\lambda_b$ )

$$\lambda_b = 0.08 \text{ FIT}$$

Unique failure rate at  $T_a = 55^\circ\text{C}$  using 60 % confidence level.

②Temperature term ( $\pi T$ )

$$\pi T = \exp\{11600 \times E_a \times (1/(273+55) - 1/(273+T_a))\}$$

$E_a$  : Activation energy (eV)

$T_a$  : Ambient temperature ( $^\circ\text{C}$ )

$\pi T$  simplified chart as  $E_a = 0.7 \text{ eV}$

$T_a$ ( $^\circ\text{C}$ )	40	50	55	60	65	70	75	80	85	90	100	110
$\pi T$	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

•MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$

## Reference about Renesas package code

Package type		Package code *1
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

\*1. First four digit

Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RX72N	R5F572NDDDBD	PLBG0224G*	51			
2	RX72N	R5F572NDDGBD	PLBG0224G*	52			
3	RX72N	R5F572NDHDBD	PLBG0224G*	53			
4	RX72N	R5F572NDHGBD	PLBG0224G*	54			
5	RX72N	R5F572NNDDDBD	PLBG0224G*	55			
6	RX72N	R5F572NNDDGBD	PLBG0224G*	56			
7	RX72N	R5F572NNHDBD	PLBG0224G*	57			
8	RX72N	R5F572NNHGBD	PLBG0224G*	58			
9	RX72N	R5F572NDDDBG	PLBG0176G*	59			
10	RX72N	R5F572NDDGBG	PLBG0176G*	60			
11	RX72N	R5F572NDHDBG	PLBG0176G*	61			
12	RX72N	R5F572NDHGBG	PLBG0176G*	62			
13	RX72N	R5F572NNDDBG	PLBG0176G*	63			
14	RX72N	R5F572NNDDGBG	PLBG0176G*	64			
15	RX72N	R5F572NNHDBG	PLBG0176G*	65			
16	RX72N	R5F572NNHGBG	PLBG0176G*	66			
17	RX72N	R5F572NDDDFB	PLQP0144K*	67			
18	RX72N	R5F572NDDGFB	PLQP0144K*	68			
19	RX72N	R5F572NDHDFB	PLQP0144K*	69			
20	RX72N	R5F572NDHGFB	PLQP0144K*	70			
21	RX72N	R5F572NNDDFB	PLQP0144K*	71			
22	RX72N	R5F572NNDGFB	PLQP0144K*	72			
23	RX72N	R5F572NNHDFB	PLQP0144K*	73			
24	RX72N	R5F572NNHGFB	PLQP0144K*	74			
25	RX72N	R5F572NDDDFC	PLQP0176K*	75			
26	RX72N	R5F572NDDGFC	PLQP0176K*	76			
27	RX72N	R5F572NDHDFC	PLQP0176K*	77			
28	RX72N	R5F572NDHGFC	PLQP0176K*	78			
29	RX72N	R5F572NNDDFC	PLQP0176K*	79			
30	RX72N	R5F572NNDGFC	PLQP0176K*	80			
31	RX72N	R5F572NNHDFC	PLQP0176K*	81			
32	RX72N	R5F572NNHGFC	PLQP0176K*	82			
33	RX72N	R5F572NDDDFP	PLQP0100K*	83			
34	RX72N	R5F572NDDGFP	PLQP0100K*	84			
35	RX72N	R5F572NDHDFP	PLQP0100K*	85			
36	RX72N	R5F572NDHGFP	PLQP0100K*	86			
37	RX72N	R5F572NNDDFP	PLQP0100K*	87			
38	RX72N	R5F572NNDGFP	PLQP0100K*	88			
39	RX72N	R5F572NNHDFP	PLQP0100K*	89			
40	RX72N	R5F572NNHGFP	PLQP0100K*	90			
41	RX72N	R5F572NDDDLK	PTLG0145K*	91			
42	RX72N	R5F572NDDGLK	PTLG0145K*	92			
43	RX72N	R5F572NDHDLK	PTLG0145K*	93			
44	RX72N	R5F572NDHGLK	PTLG0145K*	94			
45	RX72N	R5F572NNDDLK	PTLG0145K*	95			
46	RX72N	R5F572NNDGLK	PTLG0145K*	96			
47	RX72N	R5F572NNHDLK	PTLG0145K*	97			
48	RX72N	R5F572NNHGLK	PTLG0145K*	98			
49				99			
50				100			